IPC ASSOCIATION ELECTRONICS	Material Com © Copyright 2005 international and H	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
upplier	Information														
Company name* Company unique ID					Unique ID Authority						Response Date*				
nsemi												2024-05-12			
Contact Name Title - Contact				act	Phon			Phone - Contact*				Email - Contact*			
Product-E	nv-Stewards		Product Env	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Rep				Representative			Phone - Representative*				Email - Representative*				
Product-E	nv-Stewards	Product Env	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Dat	e Vers	ion	Manufacturing Site			Weight*	UOM	Unit Type
		TIP142G BIP T0247 NPI		BIP T0247 NPN 1	0A 100V	A 100V		2024-05-12 CN5			6856.24		mg	Each	
	turing Process Inform		Forminal Paga	Alloy	-STD-020 MS	I Dating	Pook Pro	ages Poy	ly Tampara	Way T	ima at Book	Tampara	turo Numb	or of Potlow Cu	alac
	· ·		Terminal Base Alloy J-STD-02 CU Alloy NA			oL Kaung	Peak Process Body Temperature Max Tim O C 30		ille at Peak	seconds 3		nes			
omments	manu 1111 (511) - amicaleu	,	CC Alloy	I	i.n.		U		IC.	30		Secol	ius J		
omnents															
or more in	nformation regarding materi	al composition	nlesse refer t	n nage 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	89.77	mg	Supplier	Silicon (Si)	7440-21-3		89.77	mg
Die Attach	281.28	mg	Supplier	Silver (Ag)	7440-22-4		70.32	mg
			Supplier	Tin (Sn)	7440-31-5		182.832	mg
			В	Antimony (Sb)	7440-36-0		28.128	mg
Lead Frame	4406.78	mg	Supplier	Silver (Ag)	7440-22-4		17.6271	mg
			Supplier	Iron (Fe)	7439-89-6		4.4068	mg
			Supplier	Copper (Cu)	7440-50-8		4384.7461	mg
Mold Compound-Black	2040.91			Metal Hydroxide	proprietary data		142.8637	mg
			Supplier	Carbon Black (C)	1333-86-4		10.2045	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1530.6825	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		306.1365	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		51.0228	mg
Plating	12.83	mg	Supplier	Tin (Sn)	7440-31-5		12.83	mg
Wire Bond - Al	24.67	mg	Supplier	Aluminum (Al)	7429-90-5		24.67	mg